# **SPECIFICATIONS**

# Dot matrix Display点阵产品规格书





MODEL: TOP-CC-1088AB-B3

客户承认	
APPROVED	
承认日期	
APPROVED DATE	

# 上海鼎辉科技股份有限公司

SHANGHAI TOPLITE TECHNOLOGY CO.,LTD.

www.ledtoplight.com.cn www.ledtoplite.com

APPROVED 批准:	CHECKED 审核:	Liugiang	PREPARED 制作:	Liucuiping
All NOVE		Liuulang		Liucuibiliz



SHANGHAI TOPLITE TECHNOLOGY CO.,LTD.

 $Http://www.ledtoplight.com.cn \\ www.ledtoplite.com$ 

### TECHNICAL DATA SHEET

TOP-CC-1088AB-B3

<FOR Φ3MM/ 8\*8 DOT MATRIX DIGITI>

1 / 7

### 1. PRODUCT INTRODUCTION

- \* Low power requirement,
- Solid state reliability.
- Wide viewing angle.
- **※** Easy mounting on P.C. boards.
- **%** RoHS compliant.

### 2. FEATURES

- \* The TOP-CC-1088AB-B3 is a 1.1 inch (28mm) matrix height 8×8 dot matrix display.
- X This device is made with white dots and black surface.

### 3. APPLICATION

- ※ Digital readout display.
- ※ Instrument panels.
- **※** Elevator.

PART NO.	SIZE	CHIP EMITTED COLOR	FACE COLOR
TOP-CC-1088AB-B3	Ф3MM /8*8 DOT MATRIX DIGITI	Blue	Black



SHANGHAI TOPLITE TECHNOLOGY CO.,LTD.

Http://www.ledtoplight.com.cn www.ledtoplite.com

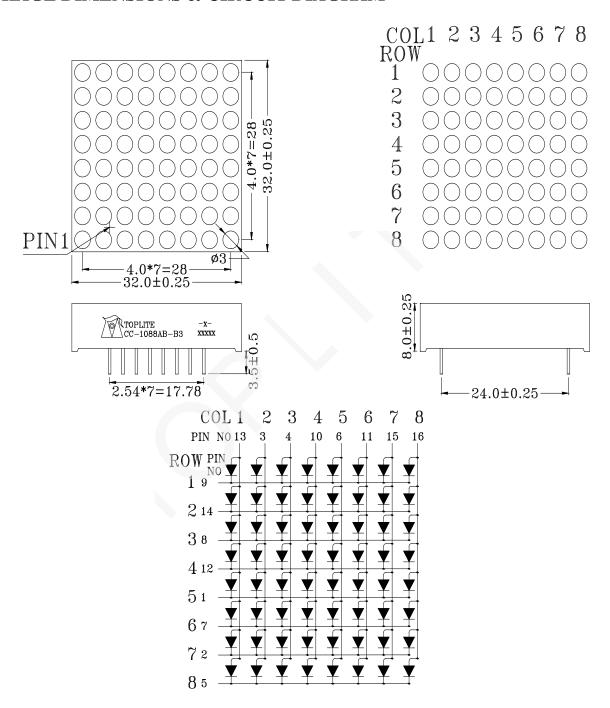
### TECHNICAL DATA SHEET

TOP-CC-1088AB-B3

<FOR Φ3MM/ 8\*8 DOT MATRIX DIGITI>

2/7

### 4. PACKAGE DIMENSIONS & CIRCUIT DIAGRAM



Note:

All dimension tolerance is  $\pm 0.25$ mm unless otherwise noted.



SHANGHAI TOPLITE TECHNOLOGY CO.,LTD.

Http://www.ledtoplight.com.cn www.ledtoplite.com

### TECHNICAL DATA SHEET

 $TOP\text{-}CC\text{-}1088AB\text{-}B3 \qquad \quad <\text{for } \text{$\Phi$3MM/ }8\text{*}8 \text{ dot Matrix digiti}>$ 

3/7

### 5. ELECTRICAL/OPTICAL CHARACTERISTIC

### 5-1. ABSOLUTE MAXIMUM RATINGS (Ta=25°C)

PARAMETER	SYMBOL	VALUE	UNIT
Reverse Voltage	$V_R$	5	V/dot*
Forward Current	$I_{\mathrm{F}}$	20	mA/dot*
Peak Forward Current (1/10 Duty Cycle)	$I_{PEAK}$	120	mA/dot*
Power Dissipation	$P_{D}$	80	mW/dot*
Operating Temperature Range	$T_{A}$	- 25 ~ + 85	$^{\circ}$
Storage Temperature Range	$T_{STG}$	- 30 ~ + 85	$^{\circ}$
Solder Temperature	Tsol	260/3	℃/s

### 5-2. ELECTRICAL-OPTICAL CHARACTERISTICS (Ta=25°C)

PARAMETER	SYM	BOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
		T	26326	32907	39489		
Luminous Intensity	$I_V$	U	39490	49362	59235	ucd	I <sub>F</sub> =10mA
		V	59236	74045	88854		
Forward Voltage	V	F	2.80	3.20	3.50	v/dot*	I <sub>F</sub> =20mA
Dominant Wavelength	λ	' d	457.5	-	467.5	nm	I <sub>F</sub> =20mA
Spectral Line Half-Width	Δ	λ	-	30	-	nm	I <sub>F</sub> =20mA
Reverse Current	I	R	-	-	20	uA	$V_R=5v$

<sup>\*</sup>The dot represents a chip.Each segment according to the principle diagram calculation of voltage and current.



SHANGHAI TOPLITE TECHNOLOGY CO.,LTD.

Http://www.ledtoplight.com.cn www.ledtoplite.com

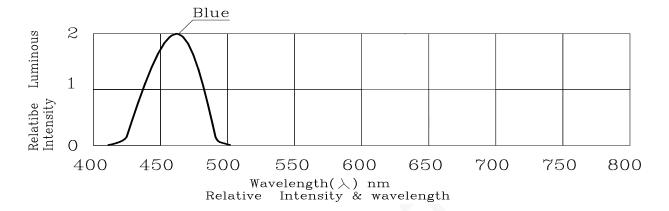
### TECHNICAL DATA SHEET

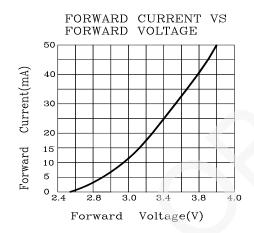
TOP-CC-1088AB-B3

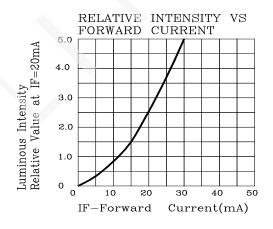
<FOR Φ3MM/ 8\*8 DOT MATRIX DIGITI>

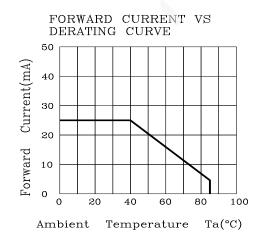
4/7

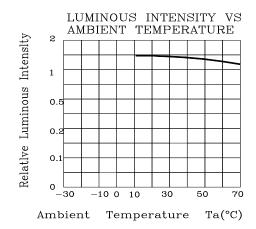
### 5-3. OPTICAL CHARACTERISTIC CURVES













SHANGHAI TOPLITE TECHNOLOGY CO.,LTD.

Http://www.ledtoplight.com.cn www.ledtoplite.com

### TECHNICAL DATA SHEET

TOP-CC-1088AB-B3 <FOR  $\Phi$ 3MM/ 8\*8 DOT MATRIX DIGITI>

5 / 7

## 6. QUALITY CONTROL AND ASSURANCE

CLASSIFICATION TEST ITEM		TEST CONDITION			
	OPERATION LIFE	Ta= Natural temperature  If=12mA-25mA per dot or Ip=80mA/duty=1/8,Pw=1.25mS  Ip=160mA/duty=1/16,Pw=1.mS(DOT)  Test time=1000HRS(-24HRS+72HRS)			
	HIGH TEMPERATURE HIGH HUMIDITY STORAGE	Evaluate storage time of the device under high temperature and high humidity $Ta=65^{\circ}\text{C}\pm5^{\circ}\text{C} \text{ RH}=90\text{-}95\%  \text{Test time}=240\text{HRS}\pm2\text{HRS}$			
ENDUTRANCE TEST	HIGH TEMPERATURE HIGH HUMIDITY REVERSE BIAS	Evaluate leakage current of the device under high temperature and high humidity $Ta=65^{\circ}\text{C}\pm5^{\circ}\text{C}  RH=90\text{-}95\% \ VR=5V$ Test time=500hrs(-24HRS+48HRS)			
	HIGH TEMPERATURE STORAGE	Evaluate reliability test of the device under high temperature Ta=85°C±5°C Test time=1000HRS(-24HRS+72HRS)			
	LOW TEMPERATURE STORAGE	Evaluate reliability test of the device under low temperature $Ta=-35$ $^{\circ}C\pm5$ $^{\circ}C$ Test time=1000HRS(-24HRS+72HRS)			
	TEMPERATURE CYCLING	Evaluate thermal expansion and cold contraction of the device under harsh temperature $Ta=85^{\circ}\text{C}\sim25^{\circ}\text{C}\sim-35^{\circ}\text{C}\sim25^{\circ}\text{C}  \text{time}=30\text{min }5\text{min }30\text{min }5\text{min }C\text{ycle}$ test:10cycles			
ENVIRONMENTAL TEST	THERMAL SHOCK	Evaluate structual and mechanical of the device under sudden thermal shock $Ta=85^{\circ}\text{C}\pm5^{\circ}\text{C}\sim-35^{\circ}\text{C}\pm5^{\circ}\text{C} time=10min\ 10min Cycle \\ test:10cycles$			
	SOLOER RESISTANCE	Evaluate performance of the device withstand thermal shock during soldering $T.sol=260^{\circ}\text{C}\pm5^{\circ}\text{C} \ time=10\pm1sec$			
	SOLOER ABILITY	Evaluate solderability of the device T.sol=230 °C±5 °C time=5±1 sec			



SHANGHAI TOPLITE TECHNOLOGY CO.,LTD.

Http://www.ledtoplight.com.cn www.ledtoplite.com

### TECHNICAL DATA SHEET

TOP-CC-1088AB-B3

<FOR Φ3MM/ 8\*8 DOT MATRIX DIGITI>

6/7

#### 7. SOLDERING CONDITIONS

The recommended conditions for soldering are as follows.

Because the component is made with epoxy resin, the units are susceptible to heat. Therefore,

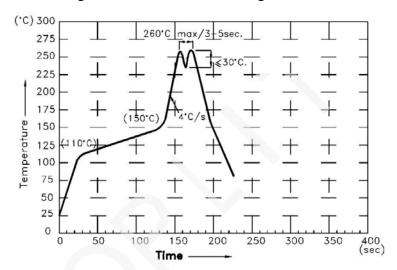
the preheating and soldering temperatures should be kept as low as possible to avoid damage.

**7-1.** Manual Soldering Conditions(with 1.5mm Iron tip ).

Iron Tip Temperature: 350°C Max, Time: 3s Max.

Position: The iron should be situated at least 2mm away from the root of the leads.

**7-2.** Through the Wave Soldering Conditions Wave Soldering Profile For Lead-free Through-hole LED.



#### **7-3.** Soldering General Notes:

- a. Recommend manual soldering to be used only for repair and rework purposes. The soldering iron should not exceed 30W in power. The tip of the soldering iron should not touch the reflector case to avoid heat-damage.
- b. Maintain the pre-heat and peak temperatures with dip units as low as possible and the times as short as is feasible, since the products are susceptible to heat during flow soldering.
- c. After soldering, least three minutes for the component to cool to room temperature before further operations.
- d. If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with toplight for compatibility.



SHANGHAI TOPLITE TECHNOLOGY CO.,LTD.

Http://www.ledtoplight.com.cn www.ledtoplite.com

### TECHNICAL DATA SHEET

TOP-CC-1088AB-B3  $\langle FOR \Phi 3MM / 8*8 DOT MATRIX DIGITI \rangle$  7 / 7

### 8. Customer optional

\*\*This is a TOPLITE standard specifications(no protective film, TOPLITE printing code).If you have special request, please make the following choices.

8-1. <b>protetive film</b>	add protetive film	do not add protetive film
	protetive film left sidemm	other
*protective film thic	ckness standard is 0.1 mm.	
8-2. <b>printing code</b>	TOPLITE standard printing code	
	Special printing code	
	Other	
8-3. Whether need prod	ucts with group	
	YES NO	Other
8-4. Other requirements	3	
a		
b		
C		